

### **Description**

#### **Features**

● 30V, 190A

 $R_{DS(ON)} \!\!< 2.6 m\Omega$  @  $V_{GS} \!=\! 10 V$ 

 $R_{DS(ON)}$ < 4.2m $\Omega$  @  $V_{GS}$  =4.5V

- Advanced Trench Technology
- Excellent R<sub>DS(ON)</sub> and Low Gate Charge
- Lead free product is acquired

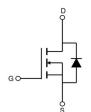
#### **Application**

- Load Switch
- PWM Application
- Power management

100% UIS 100% ΔVds







Schematic Diagram

## **Package Marking and Ordering Information**

| _ | Device Marking | Device    | OUTLINE | Device Package | Reel Size | Reel<br>(PCS) | Per Carton<br>(PCS) |
|---|----------------|-----------|---------|----------------|-----------|---------------|---------------------|
|   | VSM190N03-T2   | VSM190N03 | TAPING  | TO-252         | 13inch    | 2500          | 25000               |

### **Absolute Maximum Ratings** (T<sub>C</sub>=25°C unless otherwise specified)

| Symbol                            | Parameter                               |                         | Max.        | Units      |
|-----------------------------------|---|-------------------------|-------------|------------|
| V <sub>DSS</sub>                  | Drain-Source Voltage                    |                         | 30          | V          |
| V <sub>GSS</sub>                  | Gate-Source Voltage                     |                         | ±20         | V          |
| 1                                 | Continuous Drain Current                | T <sub>C</sub> = 25 °C  | 190         | Α          |
| I <sub>D</sub>                    |   | T <sub>C</sub> = 100 °C | 124         | Α          |
| $I_{DM}$                          | Pulsed Drain Current note1              |                         | 760         | Α          |
| Eas                               | Single Pulsed Avalanche Energy note2    |                         | 361         | mJ         |
| P <sub>D</sub>                    | Power Dissipation                       | T <sub>C</sub> = 25°C   | 178         | W          |
| R <sub>0JC</sub>                  | Thermal Resistance, Junction to Case    |                         | 0.84        | °C/W       |
| T <sub>J</sub> , T <sub>STG</sub> | Operating and Storage Temperature Range |                         | -55 to +175 | $^{\circ}$ |



# **Electrical Characteristics** (Tc=25 °C unless otherwise specified)

| Symbol                  | Parameter  | Test Condition   | Min. | Тур. | Max.         | Units |  |  |  |
|-------------------------|--|--|------|------|--------------|-------|--|--|--|
| Off Characteristic      |  |  |      |      |              |       |  |  |  |
| V <sub>(BR)DSS</sub>    | Drain-Source Breakdown Voltage                         | V <sub>GS</sub> =0V, I <sub>D</sub> =250µA                             | 30   | _    | -            | V     |  |  |  |
| I <sub>DSS</sub>        | Zero Gate Voltage Drain Current                        | V <sub>DS</sub> =30V, V <sub>GS</sub> =0V,                             | -    | -    | 1.0          | μA    |  |  |  |
| I <sub>GSS</sub>        | Gate to Body Leakage Current                           | V <sub>DS</sub> =0V, V <sub>GS</sub> = ±20V                            | -    | -    | ±100         | nA    |  |  |  |
| On Characteristics      |  |  |      |      |              |       |  |  |  |
| $V_{GS(th)}$            | Gate Threshold Voltage                                 | $V_{DS}=V_{GS}$ , $I_{D}=250\mu A$                                     | 1.0  | 1.6  | 2.5          | V     |  |  |  |
|                         | Static Drain-Source on-Resistance                      | V <sub>GS</sub> =10V, I <sub>D</sub> =20A                              | -    | 2    | 2.6          | m O   |  |  |  |
| $R_{DS(on)}$            | note3  | V <sub>GS</sub> =4.5V, I <sub>D</sub> =10A                             | -    | 3    | 4.2          | mΩ    |  |  |  |
| Dynamic Characteristics |  |  |      |      |              |       |  |  |  |
| $C_{iss}$               | Input Capacitance                                      | V <sub>DS</sub> =15V, V <sub>GS</sub> =0V,                             | -    | 6847 | -            | pF    |  |  |  |
| Coss                    | Output Capacitance                                     |  | -    | 940  | -            | pF    |  |  |  |
| C <sub>rss</sub>        | Reverse Transfer Capacitance                           | f=1.0MHz   | -    | 604  | -            | pF    |  |  |  |
| Qg                      | Total Gate Charge                                      | - V <sub>DS</sub> =15V, I <sub>D</sub> =30A,<br>- V <sub>GS</sub> =10V | -    | 93   | -            | nC    |  |  |  |
| $Q_{gs}$                | Gate-Source Charge                                     |  | -    | 14   | -            | nC    |  |  |  |
| $Q_{gd}$                | Gate-Drain("Miller") Charge                            |  | -    | 21   | -            | nC    |  |  |  |
| Switching               | Characteristics  |  |      |      |              |       |  |  |  |
| $t_{d(on)}$             | Turn-on Delay Time                                     | $V_{DS}$ =15V,<br>$I_{D}$ =30A, $R_{GEN}$ =3 $\Omega$ ,                | -    | 16   | -            | ns    |  |  |  |
| t <sub>r</sub>          | Turn-on Rise Time                                      |  | -    | 9    | -            | ns    |  |  |  |
| t <sub>d(off)</sub>     | Turn-off Delay Time                                    |  | -    | 65   | -            | ns    |  |  |  |
| t <sub>f</sub>          | Turn-off Fall Time                                     | V <sub>GS</sub> =10V   | -    | 18   | -            | ns    |  |  |  |
| Drain-Sou               | rce Diode Characteristics and Maxim                    | um Ratings   |      |      |              |       |  |  |  |
|                         | Maximum Continuous Drain to Source Diode Forward       |  |      |      | 400          | Δ.    |  |  |  |
| Is                      | Current  | -  | -    | 190  | A            |       |  |  |  |
| I <sub>SM</sub>         | Maximum Pulsed Drain to Source Diode Forward Current   |  |      | -    | 760          | Α     |  |  |  |
| $V_{SD}$                | Drain to Source Diode Forward                          | V <sub>GS</sub> =0V, I <sub>S</sub> =30A                               |      |      | 1.2          | V     |  |  |  |
| V SD                    | Voltage  |  | -    | -    | 1.2          | V     |  |  |  |
| trr                     | Body Diode Reverse Recovery Time                       |  | -    | 29   | -            | ns    |  |  |  |
| Qrr                     | Body Diode Reverse Recovery $I_F=20A,dI/dt=100A/\mu s$ |  |      | 19   | ı <u>.</u> T | nC    |  |  |  |
| QΠ                      | Charge   |  |      | 19   | _            | 110   |  |  |  |

Notes:1. Repetitive Rating: Pulse Width Limited by Maximum Junction Temperature

- 2. EAS condition: TJ=25  $^{\circ}\text{C}$  , VDD=15V, VG=10V, L=0.5mH, RG=25 $\Omega$ , IAS=38A
- 3. Pulse Test: Pulse Width≤300µs, Duty Cycle≤0.5%



# **Typical Performance Characteristics**

Figure1: Output Characteristics

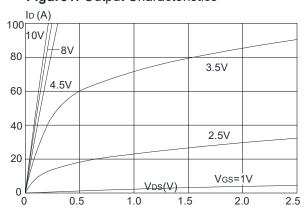


Figure 3:On-resistance vs. Drain Current

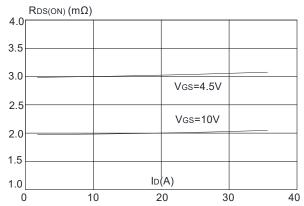


Figure 5: Gate Charge Characteristics

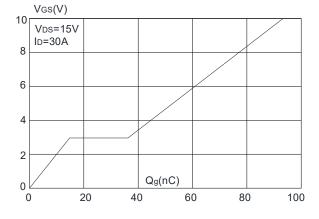


Figure 2: Typical Transfer Characteristics

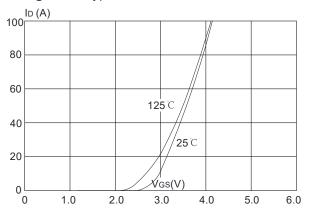


Figure 4: Body Diode Characteristics

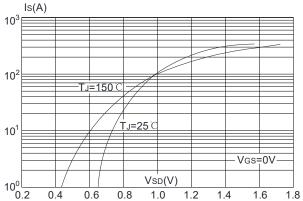
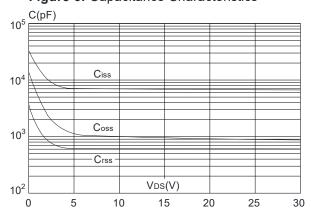


Figure 6: Capacitance Characteristics





**Figure 7:** Normalized Breakdown Voltage vs. Junction Temperature

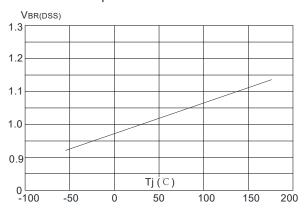
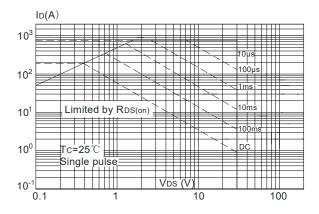
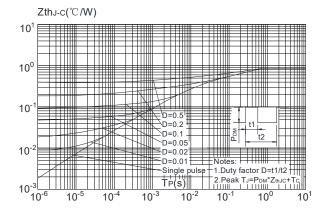


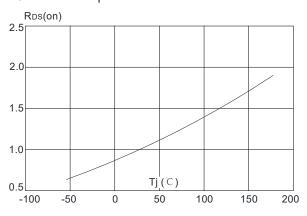
Figure 9: Maximum Safe Operating Area



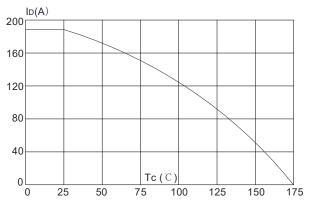
**Figure.11:** Maximum Effective Transient Thermal Impedance, Junction-to-Case



**Figure 8:** Normalized on Resistance vs. Junction Temperature



**Figure 10:** Maximum Continuous Drain Current vs. Case Temperature





## **Test Circuit**

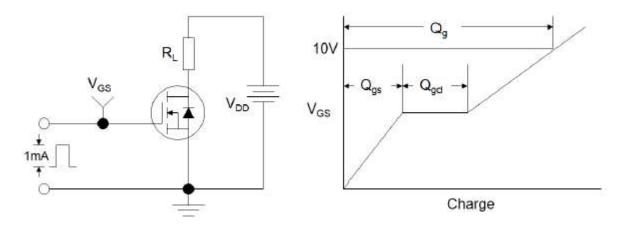


Figure1:Gate Charge Test Circuit & Waveform

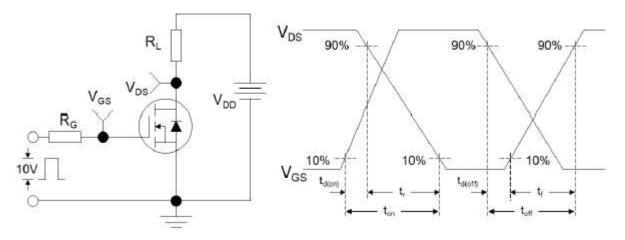


Figure 2: Resistive Switching Test Circuit & Waveforms

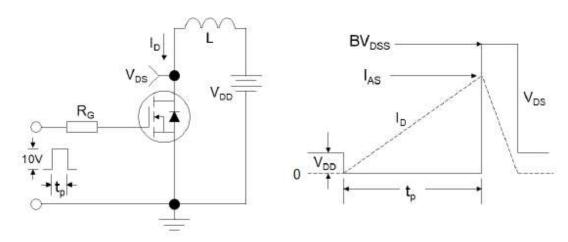


Figure 3:Unclamped Inductive Switching Test Circuit & Waveforms